

# LMH6714/ LMH6720/ LMH6722/ LMH6722Q Wideband Video Op Amp; Single, Single with Shutdown and Quad

Check for Samples: [LMH6714](#), [LMH6720](#), [LMH6722](#), [LMH6722-Q1](#)

## FEATURES

- 400MHz ( $A_V = +2V/V$ ,  $V_{OUT} = 500mV_{PP}$ ) -3dB BW
- 250MHz ( $A_V = +2V/V$ ,  $V_{OUT} = 2V_{PP}$ ) -3dB BW
- 0.1dB Gain Flatness to 120MHz
- Low Power: 5.6mA
- TTL Compatible Shutdown Pin (LMH6720)
- Very Low Diff. Gain, Phase: 0.01%, 0.01° (LMH6714)
- -58 HD2/ -70 HD3 at 20MHz
- Fast Slew Rate: 1800V/ $\mu$ s
- Low Shutdown Current: 500uA (LMH6720)
- 11ns Turn on Time (LMH6720)
- 7ns Shutdown Time (LMH6720)
- Unity Gain Stable
- Improved Replacement for CLC400,401,402,404,406 and 446 (LMH6714)
- Improved Replacement for CLC405 (LMH6720)
- Improved Replacement for CLC415 (LMH6722)
- LMH6722QSD is AEC-Q100 Grade 1 Qualified and is Manufactured on an Automotive Grade Flow

## APPLICATIONS

- HDTV, NTSC & PAL Video Systems
- Video Switching and Distribution
- Wideband Active Filters
- Cable Drivers
- High Speed Multiplexer (LMH6720)
- Programmable Gain Amplifier (LMH6720)
- Automotive (LMH6722Q)

## DESCRIPTION

The LMH6714/LMH6720/LMH6722 series combine Texas Instruments' VIP10 high speed complementary bipolar process with Texas Instruments' current feedback topology to produce a very high speed op amp. These amplifiers provide a 400MHz small signal bandwidth at a gain of +2V/V and a 1800V/ $\mu$ s slew rate while consuming only 5.6mA from  $\pm 5V$  supplies.

The LMH6714/LMH6720/LMH6722 series offer exceptional video performance with its 0.01% and 0.01° differential gain and phase errors for NTSC and PAL video signals while driving a back terminated 75 $\Omega$  load. They also offer a flat gain response of 0.1dB to 120MHz. Additionally, they can deliver 70mA continuous output current. This level of performance makes them an ideal op amp for broadcast quality video systems.

The LMH6714/LMH6720/LMH6722's small packages (SOIC, SOT-23 and WSON), low power requirement, low noise and distortion allow the LMH6714/LMH6720/LMH6722 to serve portable RF applications. The high impedance state during shutdown makes the LMH6720 suitable for use in multiplexing multiple high speed signals onto a shared transmission line. The LMH6720 is also ideal for portable applications where current draw can be reduced with the shutdown function.



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## Typical Performance

Non-Inverting Small Signal Frequency Response

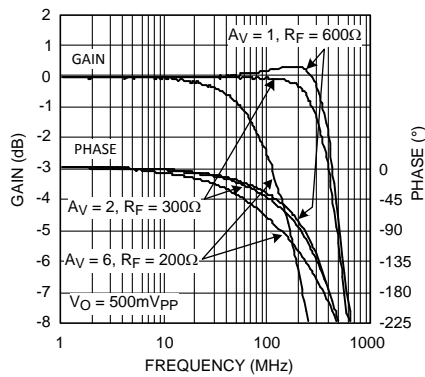


Figure 1.

Differential Gain and Phase vs. Number of Video Loads (LMH6714)

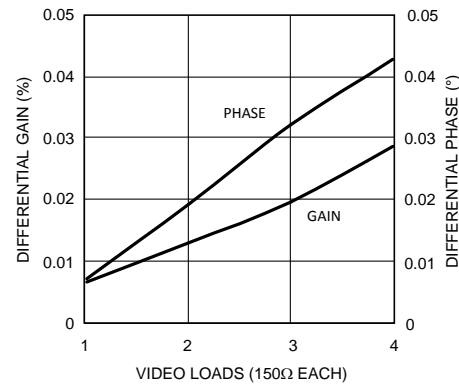


Figure 2.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings<sup>(1)(2)</sup>

|                                     |                  |   |
|-------------------------------------|------------------|---|
| ESD Tolerance <sup>(3)</sup>        | Human Body Model | 2000V                                     |
|                                     | Machine Model    | 200V                                      |
| V <sub>CC</sub>                     |                  | ±6.75V                                    |
| I <sub>OUT</sub>                    |                  | See <sup>(4)</sup>                        |
| Common Mode Input Voltage           |                  | ±V <sub>CC</sub>                          |
| Differential Input Voltage          |                  | 2.2V                                      |
| Maximum Junction Temperature        |                  | +150°C                                    |
| Storage Temperature Range           |                  | -65°C to +150°C                           |
| Lead Temperature (soldering 10 sec) |                  | +300°C                                    |
| Storage Temperature Range           |                  | -65°C to +150°C                           |
| Shutdown Pin Voltage <sup>(5)</sup> |                  | +V <sub>CC</sub> to V <sub>CC</sub> /2-1V |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For specific specifications, see the Electrical Characteristics tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) Human Body Model, applicable std. MIL-STD-883, Method 3015.7. Machine Model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC). Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC).
- (4) The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations. See the [POWER DISSIPATION](#) section for more details.
- (5) The shutdown pin is designed to work between 0 and V<sub>CC</sub> with split supplies (V<sub>CC</sub> = -V<sub>EE</sub>). With single supplies (V<sub>EE</sub> = ground) the shutdown pin should not be taken below V<sub>CC</sub>/2.

## Operating Ratings<sup>(1)</sup>

|                            |            |  |
|----------------------------|------------|--|
| Thermal Resistance Package |            | ( $\theta_{JA}$ )                        |
| 5-Pin SOT-23 (DBV)         |            | 232°C/W                                  |
| 6-Pin SOT-23 (DBV)         |            | 198°C/W                                  |
| 8-Pin SOIC (D)             |            | 145°C/W                                  |
| 14-Pin SOIC (D)            |            | 130°C/W                                  |
| 14-Pin TSSOP (PW)          |            | 160°C/W                                  |
| 14-Pin WSON (NHK)          |            | 46°C/W                                   |
| Operating Temperature      | LMH6722Q   | –40°C to 125°C                           |
|                            | All others | –40°C to 85°C                            |
| Supply Voltage Range       |            | 8V ( $\pm 4V$ ) to 12.5V ( $\pm 6.25V$ ) |

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For specific specifications, see the Electrical Characteristics tables.

## Electrical Characteristics

Unless specified,  $A_V = +2$ ,  $R_F = 300\Omega$ :  $V_{CC} = \pm 5V$ ,  $R_L = 100\Omega$ , LMH6714/LMH6720/LMH6722. **Boldface** limits apply at temperature extremes.

| Symbol                               | Parameter                                  | Conditions                            | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Units           |
|--------------------------------------|--|---------------------------------------|--------------------|--------------------|--------------------|-----------------|
| <b>Frequency Domain Response</b>     |  |                                       |                    |                    |                    |                 |
| SSBW                                 | –3dB Bandwidth                             | $V_{OUT} = 0.5V_{PP}$                 | 345                | 400                |                    | MHz             |
| LSBW                                 | –3dB Bandwidth                             | $V_{OUT} = 2.0V_{PP}$                 | 200                | 250                |                    | MHz             |
| LSBW                                 | –3dB Bandwidth, LMH6722 TSSOP package only | $V_{OUT} = 2.0V_{PP}$                 | 170                | 250                |                    | MHz             |
|                                      | Gain Flatness                              | $V_{OUT} = 2V_{PP}$                   |                    |                    |                    |                 |
| GFP                                  | Peaking                                    | DC to 120MHz                          |                    | 0.1                |                    | dB              |
| GFR                                  | Rolloff                                    | DC to 120MHz                          |                    | 0.1                |                    | dB              |
| LPD                                  | Linear Phase Deviation                     | DC to 120MHz                          |                    | 0.5                |                    | deg             |
| DG                                   | Differential Gain                          | $R_L = 150\Omega$ , 4.43MHz (LMH6714) |                    | 0.01               |                    | %               |
| DG                                   | Differential Gain                          | $R_L = 150\Omega$ , 4.43MHz (LMH6720) |                    | 0.02               |                    | %               |
| DP                                   | Differential Phase                         | $R_L = 150\Omega$ , 4.43MHz           |                    | 0.01               |                    | deg             |
| <b>Time Domain Response</b>          |  |                                       |                    |                    |                    |                 |
| TRS                                  | Rise and Fall Time                         | .5V Step                              |                    | 1.5                |                    | ns              |
| TRL                                  |  | 2V Step                               |                    | 2.6                |                    | ns              |
| $t_s$                                | Settling Time to 0.05%                     | 2V Step                               |                    | 12                 |                    | ns              |
| SR                                   | Slew Rate                                  | 6V Step                               | 1200               | 1800               |                    | V/ $\mu$ s      |
| <b>Distortion and Noise Response</b> |  |                                       |                    |                    |                    |                 |
| HD2                                  | 2nd Harmonic Distortion                    | $2V_{PP}$ , 20MHz                     |                    | –58                |                    | dBc             |
| HD3                                  | 3rd Harmonic Distortion                    | $2V_{PP}$ , 20MHz                     |                    | –70                |                    | dBc             |
| IMD                                  | 3rd Order Intermodulation Products         | 10MHz, $P_{OUT} = 0dBm$               |                    | –78                |                    | dBc             |
|                                      | Equivalent Input Noise                     |                                       |                    |                    |                    |                 |
| VN                                   | Non-Inverting Voltage                      | >1MHz                                 |                    | 3.4                |                    | nV/ $\sqrt{Hz}$ |
| NICN                                 | Inverting Current                          | >1MHz                                 |                    | 10                 |                    | pA/ $\sqrt{Hz}$ |
| ICN                                  | Non-Inverting Current                      | >1MHz                                 |                    | 1.2                |                    | pA/ $\sqrt{Hz}$ |

- (1) All limits are specified by testing, design, or statistical analysis.

- (2) Typical values represent the most likely parametric norm at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not ensured on shipped production material.

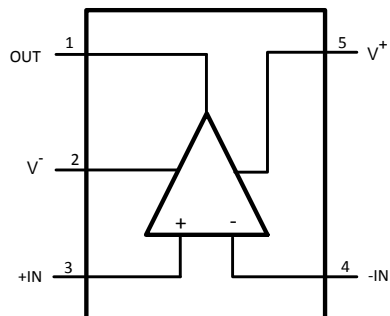
## Electrical Characteristics (continued)

Unless specified,  $A_V = +2$ ,  $R_F = 300\Omega$ ;  $V_{CC} = \pm 5V$ ,  $R_L = 100\Omega$ , LMH6714/LMH6720/LMH6722. **Boldface** limits apply at temperature extremes.

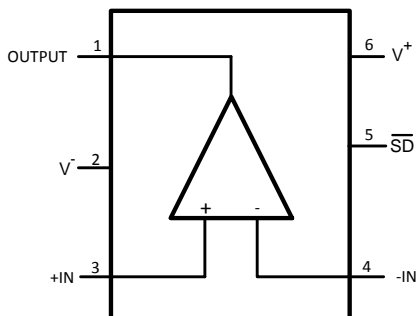
| Symbol                    | Parameter                      | Conditions                               |         | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Units |
|---------------------------|--------------------------------|--|---------|--------------------|--------------------|--------------------|-------|
| Static, DC Performance    |                                |  |         |                    |                    |                    |       |
| V <sub>IO</sub>           | Input Offset Voltage           |  |         |                    | ±0.2               | ±6<br>±8           | mV    |
| DVIO                      | Average Drift                  |  |         |                    | 8                  |                    | µV/°C |
| I <sub>BN</sub>           | Input Bias Current             | Non-Inverting                            |         |                    | ±1                 | ±10<br>±15         | µA    |
| DIBN                      | Average Drift                  |  |         |                    | 4                  |                    | nA/°C |
| I <sub>BI</sub>           | Input Bias Current             | Inverting                                |         |                    | −4                 | ±12<br>±20         | µA    |
| DIBI                      | Average Drift                  |  |         |                    | 41                 |                    | nA/°C |
| PSRR                      | Power Supply Rejection Ratio   | DC                                       |         | 48<br>47           | 58                 |                    | dB    |
| CMRR                      | Common Mode Rejection Ratio    | DC                                       |         | 48<br>45           | 54                 |                    | dB    |
| I <sub>CC</sub>           | Supply Current                 | R <sub>L</sub> = ∞                       | LMH6714 | 4.5                | 5.6                | 7.5                | mA    |
|                           |                                |  | LMH6720 | 3                  |                    | 8                  |       |
|                           |                                |  | LMH6722 | 18<br>15           | 22.5               | 30<br>32           |       |
| I <sub>CCI</sub>          | Supply Current During Shutdown | LMH6720                                  |         |                    | 500                | 670                | µA    |
| Miscellaneous Performance |                                |  |         |                    |                    |                    |       |
| R <sub>IN</sub>           | Input Resistance               | Non-Inverting                            |         |                    | 2                  |                    | MΩ    |
| C <sub>IN</sub>           | Input Capacitance              | Non-Inverting                            |         |                    | 1.0                |                    | pF    |
| R <sub>OUT</sub>          | Output Resistance              | Closed Loop                              |         |                    | 0.06               |                    | Ω     |
| V <sub>OUT</sub>          | Output Voltage Range           | R <sub>L</sub> = ∞                       |         | ±3.5<br>±3.4       | ±3.9               |                    | V     |
|                           |                                | R <sub>L</sub> = 100Ω                    |         | ±3.6<br>±3.4       | ±3.8               |                    |       |
| CMIR                      | Input Voltage Range            | Common Mode                              |         |                    | ±2.2               |                    | V     |
| I <sub>OUT</sub>          | Output Current <sup>(3)</sup>  | V <sub>IN</sub> = 0V, Max Linear Current |         | 50                 | 70                 |                    | mA    |
| OFFMAX                    | Voltage for Shutdown           | LMH6720                                  |         |                    |                    | 0.8                | V     |
| ONMIN                     | Voltage for Turn On            | LMH6720                                  |         | 2.0                |                    |                    | V     |
| IIH                       | Current Turn On                | LMH6720, $\overline{SD}$ = 2.0V          |         | −20<br>−30         | 2                  | 20<br>30           | µA    |
| IIL                       | Current Shutdown               | LMH6720, $\overline{SD}$ = .8V           |         | −600               | −400               | −100               | µA    |
| IOZ                       | R <sub>OUT</sub> Shutdown      | LMH6720, $\overline{SD}$ = .8V           |         | 0.2                | 1.8                |                    | MΩ    |
| t <sub>on</sub>           | Turn on Time                   | LMH6720                                  |         |                    | 11                 |                    | ns    |
| t <sub>off</sub>          | Turn off Time                  | LMH6720                                  |         |                    | 7                  |                    | ns    |

(3) The maximum output current ( $I_{OUT}$ ) is determined by device power dissipation limitations. See the [POWER DISSIPATION](#) section for more details.

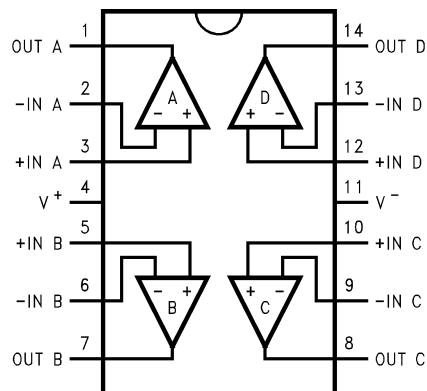
## CONNECTION DIAGRAMS



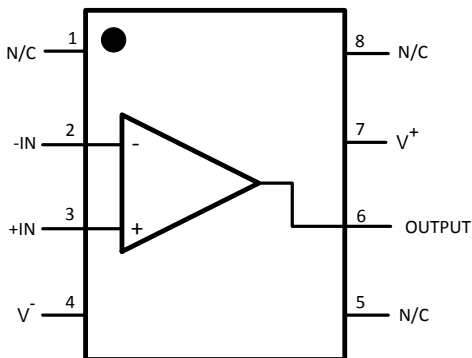
**Figure 3. 5-Pin SOT-23  
(LMH6714) (Top View)**  
See Package Number DBV



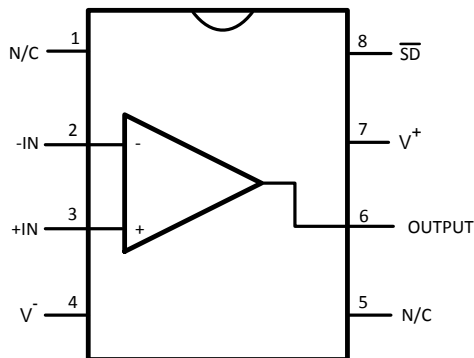
**Figure 4. 6-Pin SOT-23  
(LMH6720) (Top View)**  
See Package Number DBV



**Figure 5. 14-Pin SOIC, TSSOP  
and WSON (LMH6722) (Top View)**  
See Package Numbers D, PW,  
and NHK



**Figure 6. 8-Pin SOIC (LMH6714) (Top View)**  
See Package Number D



**Figure 7. 8-Pin SOIC (LMH6720) (Top View)**  
See Package Number D

## Typical Performance Characteristics

( $V^+ = +5V$ ,  $V^- = -5V$ ,  $A_V = 2$ ,  $R_F = 300\Omega$ ,  $R_L = 100\Omega$  Unless Specified).

Non-Inverting Small Signal Frequency Response

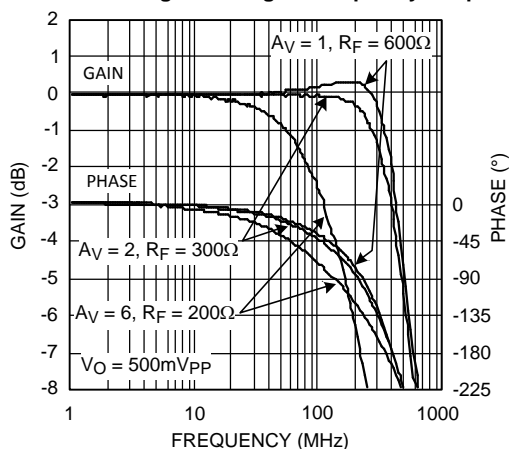


Figure 8.

Non-Inverting Large Signal Frequency Response

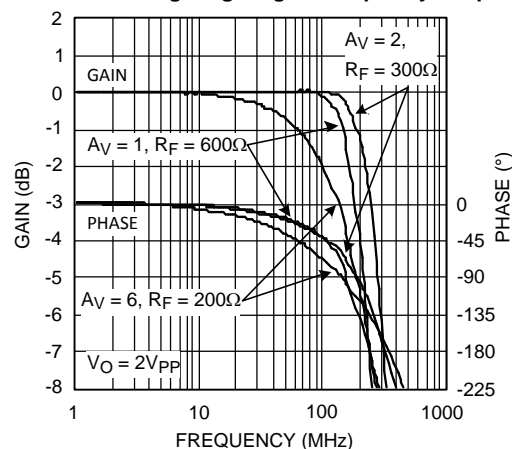


Figure 9.

Inverting Frequency Response

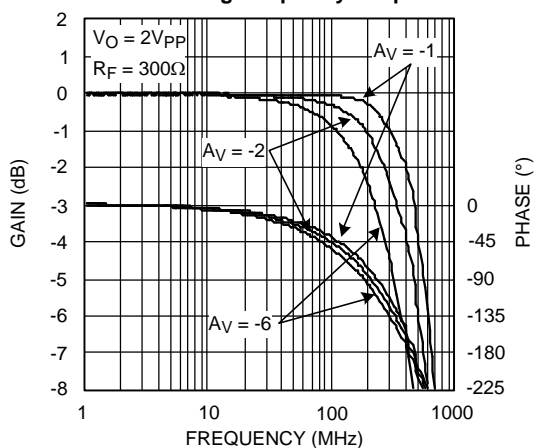


Figure 10.

Non-Inverting Frequency Response vs.  $V_O$

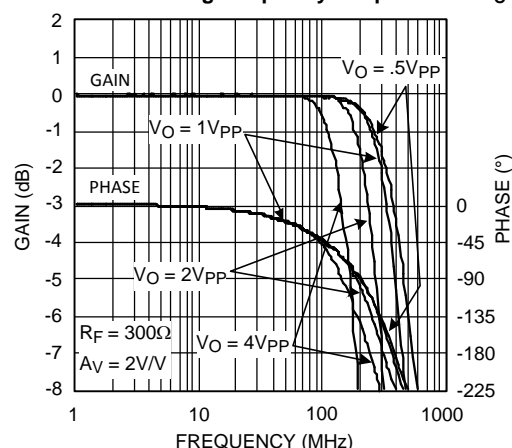


Figure 11.

Inverting Frequency Response vs.  $V_O$

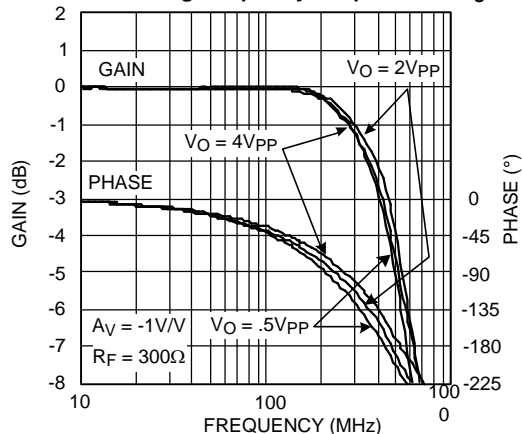


Figure 12.

Harmonic Distortion vs. Frequency

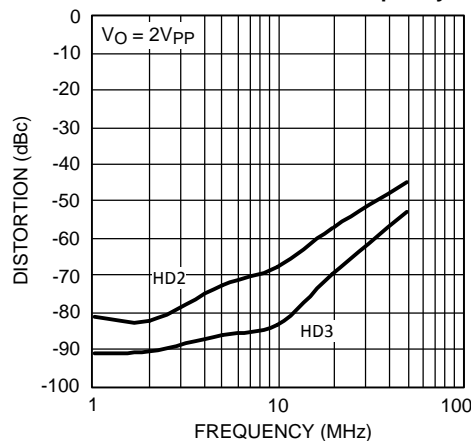


Figure 13.

## Typical Performance Characteristics (continued)

( $V^+ = +5V$ ,  $V^- = -5V$ ,  $A_V = 2$ ,  $R_F = 300\Omega$ ,  $R_L = 100\Omega$  Unless Specified).

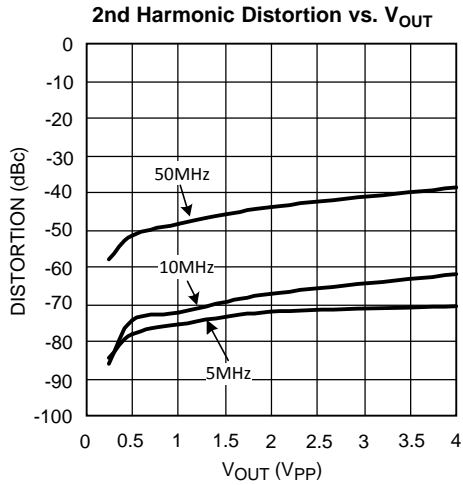


Figure 14.

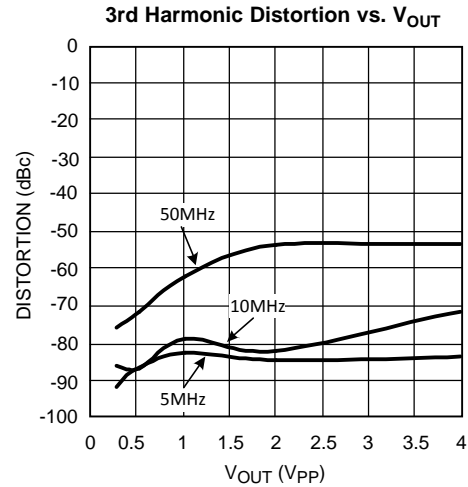


Figure 15.

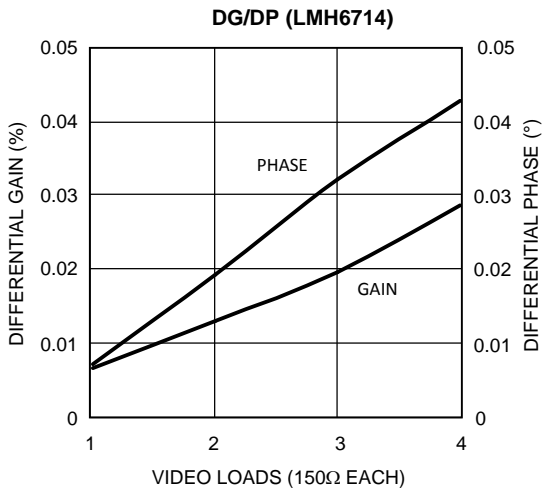


Figure 16.

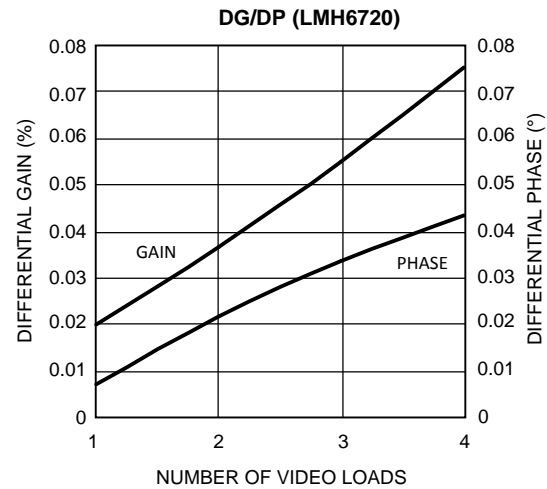


Figure 17.

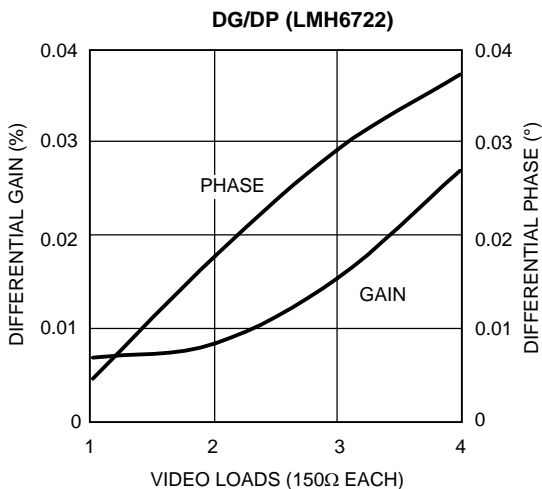


Figure 18.

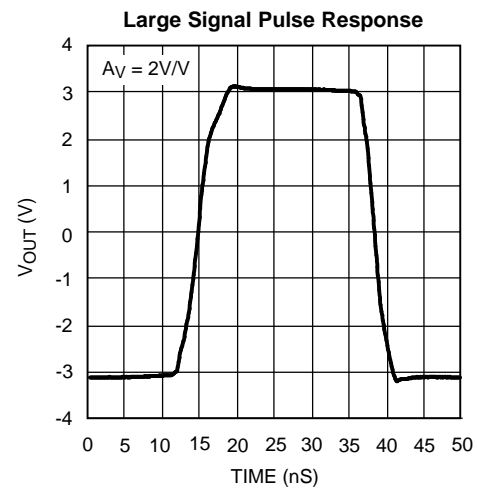


Figure 19.

## Typical Performance Characteristics (continued)

( $V^+ = +5V$ ,  $V^- = -5V$ ,  $A_V = 2$ ,  $R_F = 300\Omega$ ,  $R_L = 100\Omega$  Unless Specified).

Small Signal Pulse Response

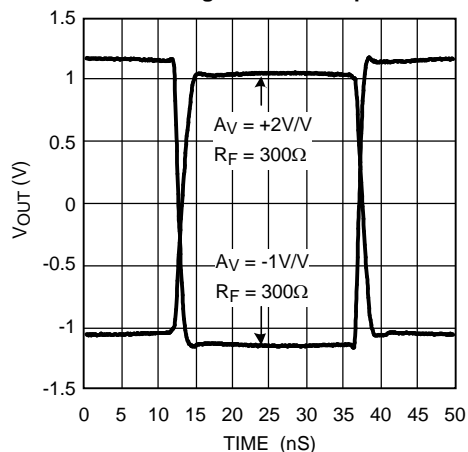


Figure 20.

Closed Loop Output Resistance

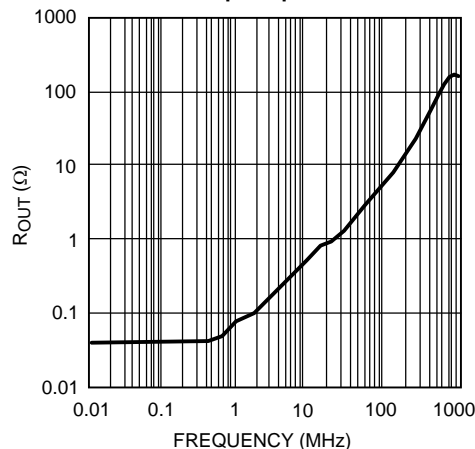


Figure 21.

Open Loop Transimpedance Z(s)

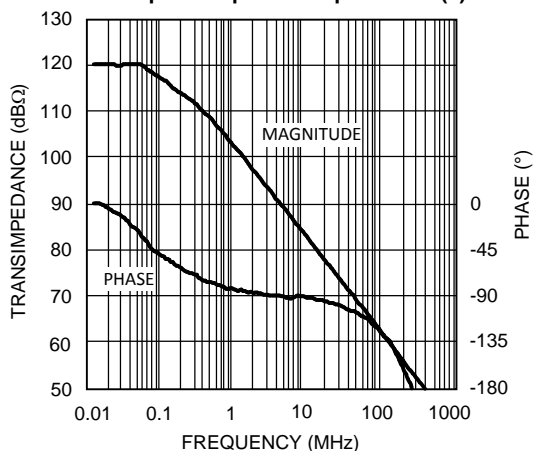


Figure 22.

PSRR vs. Frequency

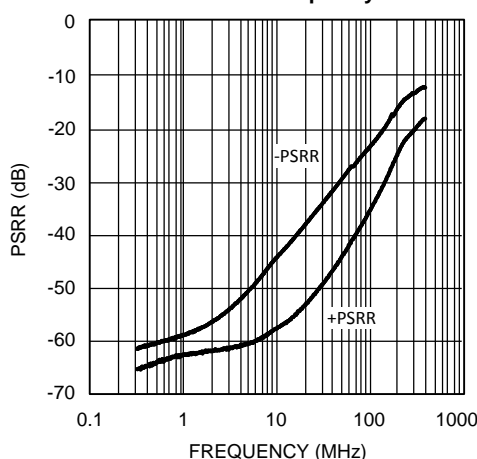


Figure 23.

CMRR vs. Frequency

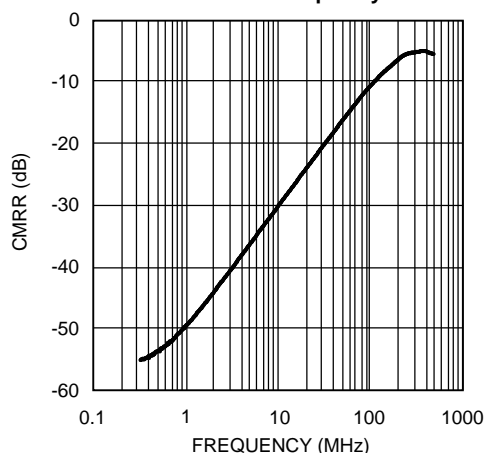


Figure 24.

Frequency Response vs.  $R_F$

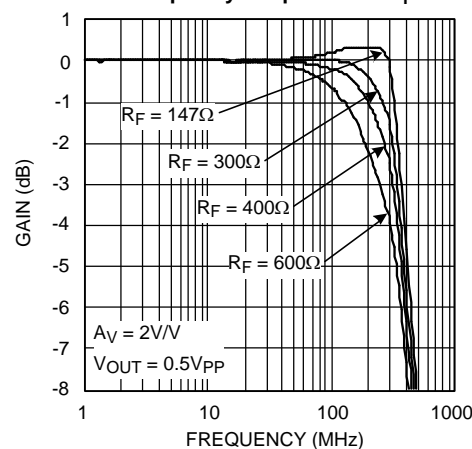


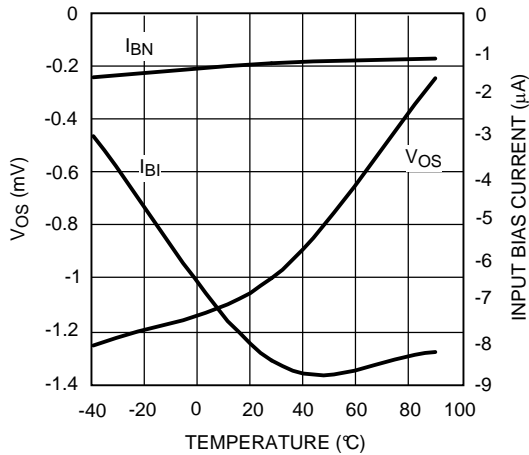
Figure 25.



## Typical Performance Characteristics (continued)

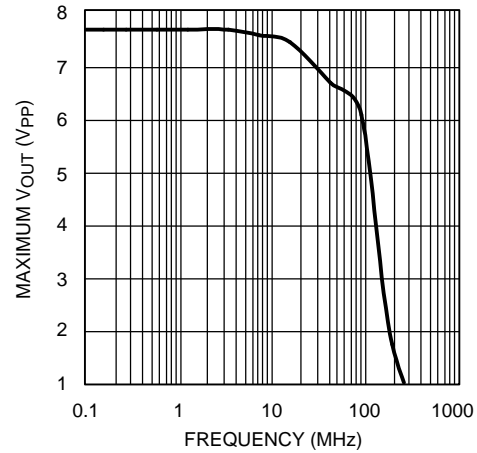
( $V^+ = +5V$ ,  $V^- = -5V$ ,  $A_V = 2$ ,  $R_F = 300\Omega$ ,  $R_L = 100\Omega$  Unless Specified).

**DC Errors vs. Temperature**



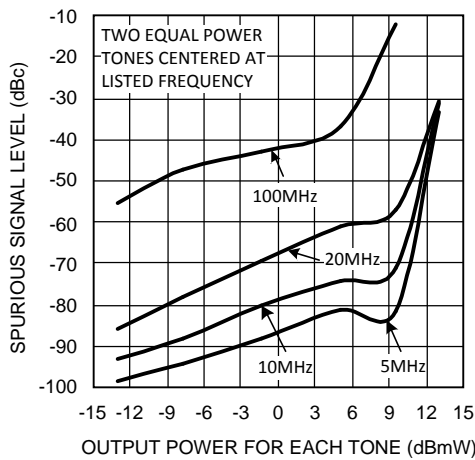
**Figure 26.**

**Maximum  $V_{OUT}$  vs. Frequency**



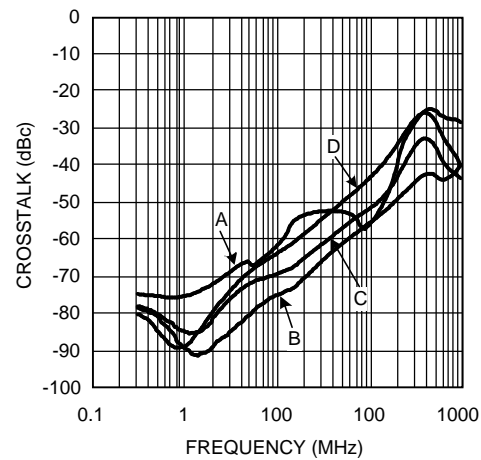
**Figure 27.**

**3rd Order Intermodulation vs. Output Power**



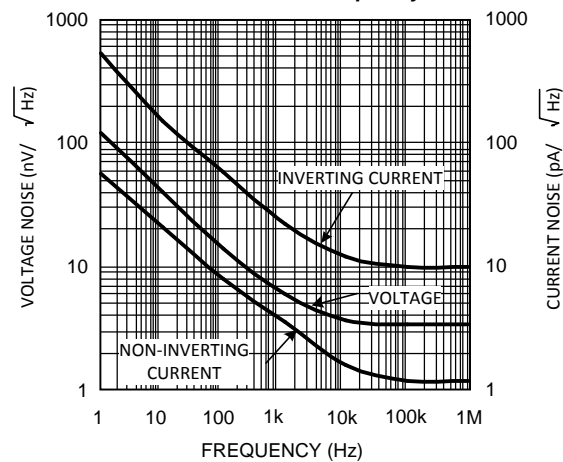
**Figure 28.**

**Crosstalk vs. Frequency (LMH6722)  
for each channel with all others active**



**Figure 29.**

**Noise vs. Frequency**



**Figure 30.**

## APPLICATION SECTION

### FEEDBACK RESISTOR SELECTION

One of the key benefits of a current feedback operational amplifier is the ability to maintain optimum frequency response independent of gain by using appropriate values for the feedback resistor ( $R_F$ ). The Electrical Characteristics and Typical Performance plots specify an  $R_F$  of 300 $\Omega$ , a gain of +2V/V and  $\pm 5V$  power supplies (unless otherwise specified). Generally, lowering  $R_F$  from its recommended value will peak the frequency response and extend the bandwidth while increasing the value of  $R_F$  will cause the frequency response to roll off faster. Reducing the value of  $R_F$  too far below its recommended value will cause overshoot, ringing and, eventually, oscillation.

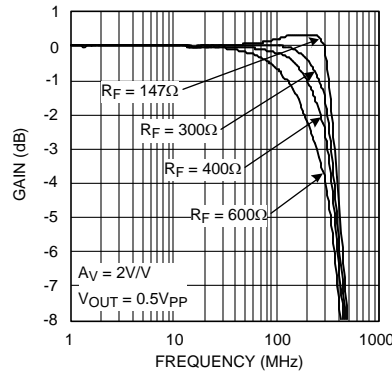


Figure 31. Frequency Response vs.  $R_F$

Figure 31 shows the LMH6714/LMH6720/LMH6722's frequency response as  $R_F$  is varied ( $R_L = 100\Omega$ ,  $A_V = +2$ ). This plot shows that an  $R_F$  of 147 $\Omega$  results in peaking. An  $R_F$  of 300 $\Omega$  gives near maximal bandwidth and gain flatness with good stability. An  $R_F$  of 400 $\Omega$  gives excellent stability with only a small bandwidth penalty. Since all applications are slightly different it is worth some experimentation to find the optimal  $R_F$  for a given circuit. Note that it is not possible to use a current feedback amplifier with the output shorted directly to the inverting input. The buffer configuration of the LMH6714/LMH6720/LMH6722 requires a 600 $\Omega$  feedback resistor for stable operation.

For more information see Application Note OA-13 (SNOA366) which describes the relationship between  $R_F$  and closed-loop frequency response for current feedback operational amplifiers. The value for the inverting input impedance for the LMH6714/LMH6720/LMH6722 is approximately 180 $\Omega$ . The LMH6714/LMH6720/LMH6722 is designed for optimum performance at gains of +1 to +6 V/V and -1 to -5V/V. When using gains of  $\pm 7V/V$  or more the low values of  $R_G$  required will make inverting input impedances very low.

When configuring the LMH6714/LMH6720/LMH6722 for gains other than +2V/V, it is usually necessary to adjust the value of the feedback resistor. Figure 32 and Figure 33 provide recommended feedback resistor values for a number of gain selections.

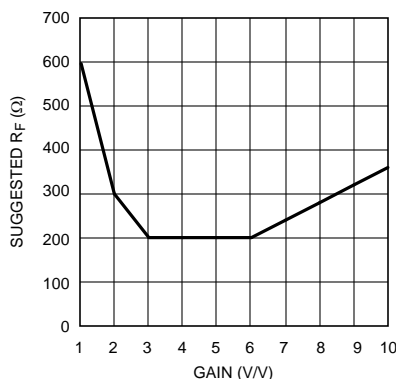


Figure 32.  $R_F$  vs. Non-Inverting Gain

In the Figure 32 and Figure 33 charts, the recommended value of  $R_F$  is depicted by the solid line, which starts high, decreases to  $200\Omega$  and begins increasing again. The reason that a higher  $R_F$  is required at higher gains is the need to keep  $R_G$  from decreasing too far below the output impedance of the input buffer. For the LMH6714/LMH6720/LMH6722 the output resistance of the input buffer is approximately  $180\Omega$  and  $50\Omega$  is a practical lower limit for  $R_G$ . Due to the limitations on  $R_G$  the LMH6714/LMH6720/LMH6722 begins to operate in a gain bandwidth limited fashion for gains of  $\pm 5V/V$  or greater.

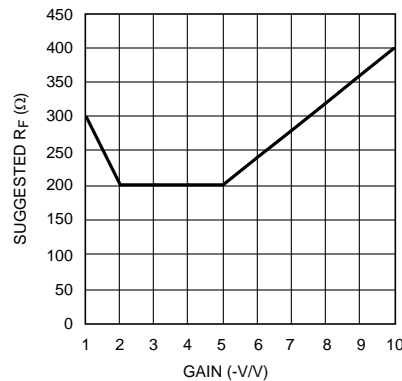


Figure 33.  $R_F$  vs. Inverting Gain

## ACTIVE FILTERS

When using any current feedback Operational Amplifier as an active filter it is important to be very careful when using reactive components in the feedback loop. Anything that reduces the impedance of the negative feedback, especially at higher frequencies, will almost certainly cause stability problems. Likewise capacitance on the inverting input needs to be avoided. See Application Notes OA-07 (SNOA365) and OA-26 (SNOA387) for more information on Active Filter applications for Current Feedback Op Amps.

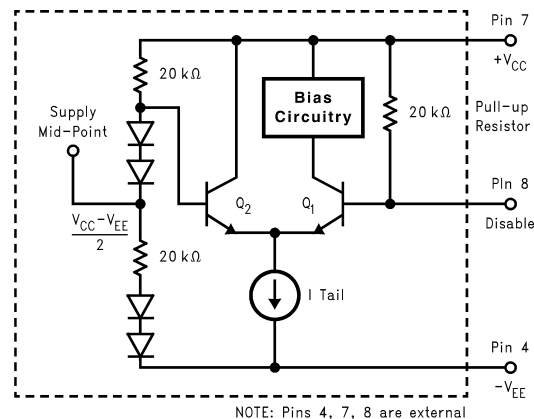


Figure 34. Enable/Disable Operation

## ENABLE/DISABLE OPERATION USING $\pm 5V$ SUPPLIES (LMH6720 ONLY)

The LMH6720 has a TTL logic compatible disable function. Apply a logic low ( $< .8V$ ) to the DS pin and the LMH6720 is disabled. Apply a logic high ( $> 2.0V$ ), or let the pin float and the LMH6720 is enabled. Voltage, not current, at the Disable pin determines the enable/disable state. Care must be exercised to prevent the disable pin voltage from going more than  $.8V$  below the midpoint of the supply voltages ( $0V$  with split supplies,  $V_{CC}/2$  with single supplies) doing so could cause transistor  $Q_1$  to Zener resulting in damage to the disable circuit. The core amplifier is unaffected by this, but disable operation could become slower as a result.

Disabled, the LMH6720 inputs and output become high impedances. While disabled the LMH6720 quiescent current is approximately 500 $\mu$ A. Because of the pull up resistor on the disable circuit the  $I_{CC}$  and  $I_{EE}$  currents are not balanced in the disabled state. The positive supply current ( $I_{CC}$ ) is approximately 500 $\mu$ A while the negative supply current ( $I_{EE}$ ) is only 200 $\mu$ A. The remaining  $I_{EE}$  current of 300 $\mu$ A flows through the disable pin.

The disable function can be used to create analog switches or multiplexers. Implement a single analog switch with one LMH6720 positioned between an input and output. Create an analog multiplexer with several LMH6720's. The LMH6720 is at it's best at a gain of 1 for multiplexer applications because there is no  $R_G$  to shunt signals to ground.

## DISABLE LIMITATIONS (LMH6720 ONLY)

The feedback Resistor ( $R_F$ ) limits off isolation in inverting gain configurations. During shutdown the impedance of the LMH6720 inputs and output become very high ( $>1M\Omega$ ), however  $R_F$  and  $R_G$  are the dominant factor for effective output impedance.

Do not apply voltages greater than  $+V_{CC}$  or less than 0V ( $V_{CC}/2$  single supply) to the disable pin. The input ESD diodes will also conduct if the signal leakage through the feedback resistors brings the inverting input near either supply rail.

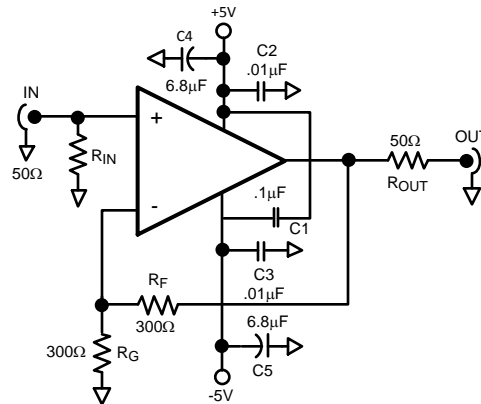


Figure 35. Typical Application with Suggested Supply Bypassing

## LAYOUT CONSIDERATIONS

Whenever questions about layout arise, use the evaluation board as a guide. The following Evaluation boards are available with sample parts:

|         |        |           |
|---------|--------|-----------|
| LMH6714 | SOT-23 | LMH730216 |
|         | SOIC   | LMH730227 |
| LMH6720 | SOT-23 | LMH730216 |
|         | SOIC   | LMH730227 |
| LMH6722 | SOIC   | LMH730231 |
|         | TSSOP  | LMH730131 |

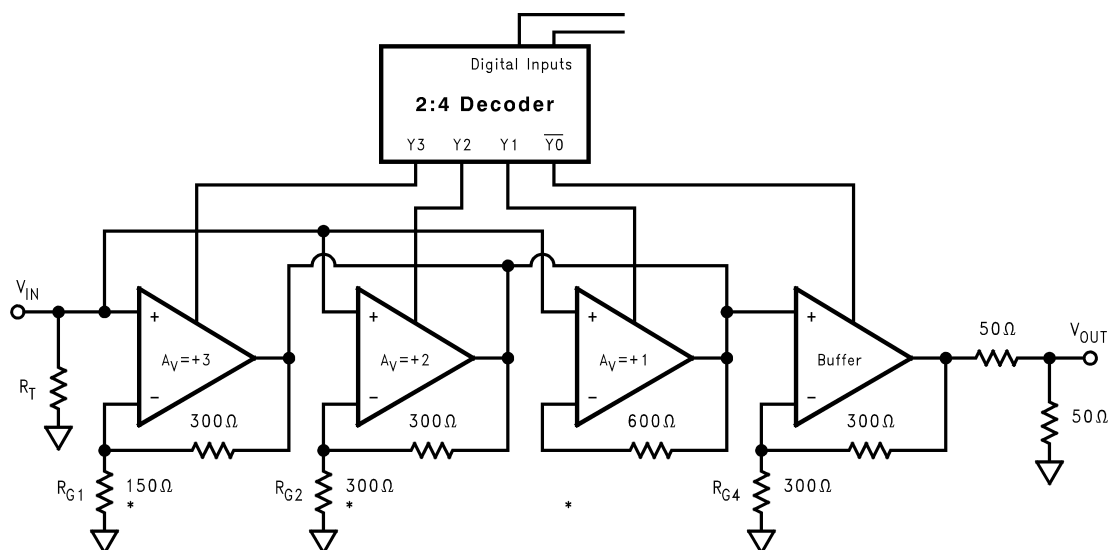
To reduce parasitic capacitances, the ground plane should be removed near the input and output pins. To reduce series inductance, trace lengths of components in the feedback loop should be minimized. For long signal paths controlled impedance lines should be used, along with impedance matching at both ends.

Bypass capacitors should be placed as close to the device as possible. Bypass capacitors from each rail to ground are applied in pairs. The larger electrolytic bypass capacitors can be located anywhere on the board, the smaller ceramic capacitors should be placed as close to the device as possible. In addition Figure 35 shows a capacitor (C1) across the supplies with no connection to ground. This capacitor is optional, however it is required for best 2nd Harmonic suppression. If this capacitor is omitted C2 and C3 should be increased to .1 $\mu$ F each.

## VIDEO PERFORMANCE

The LMH6714/LMH6720/LMH6722 has been designed to provide excellent performance with both PAL and NTSC composite video signals. Performance degrades as the loading is increased, therefore best performance will be obtained with back terminated loads. The back termination reduces reflections from the transmission line and effectively masks capacitance from the amplifier output stage. While all parts offer excellent video performance the LMH6714 and LMH6722 are slightly better than the LMH6720.

## WIDE BAND DIGITAL PROGRAMMABLE GAIN AMPLIFIER (LMH6720 ONLY)



\*NOTE: Selectable gains can be changed by using different  $R_g$  resistors.

Figure 36. Wideband Digitally Controlled Programmable Gain Amplifier

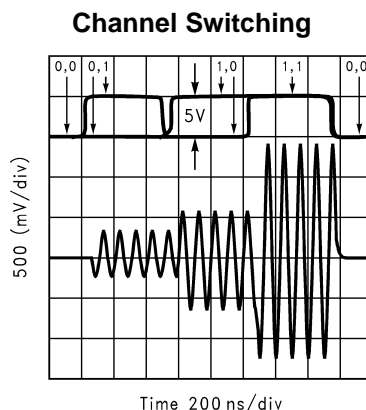


Figure 37. PGA Output

As shown in [Figure 36](#) and [Figure 37](#) the LMH6720 can be used to construct a digitally controlled programmable gain amplifier. Each amplifier is configured to provide a digitally selectable gain. To provide for accurate gain settings, 1% or better tolerance is recommended on the feedback and gain resistors. The gain provided by each digital code is arbitrary through selection of the feedback and gain resistor values.

## AMPLITUDE EQUALIZATION

Sending signals over coaxial cable greater than 50 meters in length will attenuate high frequency signal components much more than lower frequency components. An equalizer can be made to pre emphasize the higher frequency components so that the final signal has less distortion. This process can be done at either end of the cable. The circuit in Figure 38 shows a receiver with some additional components in the feedback loop to equalize the incoming signal. The RC networks peak the signal at higher frequencies. This peaking is a piecewise linear approximation of the inverse of the frequency response of the coaxial cable. Figure 39 shows the effect of this equalization on a digital signal that has passed through 150 meters of coaxial cable. Figure 40 shows a Bode plot of the frequency response of the circuit in Figure 38 along with equations needed to design the pole and zero frequencies. Figure 41 shows a network analyzer plot of an LMH6714/LMH6720/LMH6722 with the following component values:

$$R_G = 309\Omega$$

$$R_1 = 450\Omega$$

$$C_1 = 470\text{pF}$$

$$R_2 = 91\Omega$$

$$C_2 = 68\text{pF}$$

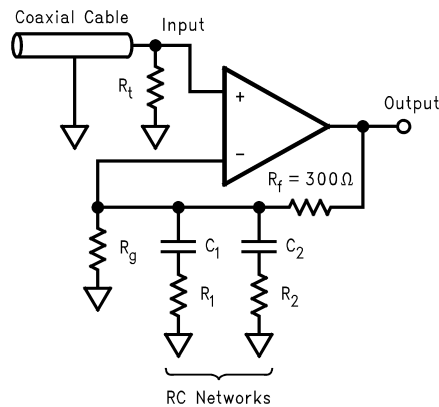


Figure 38. Equalizer Circuit Schematic

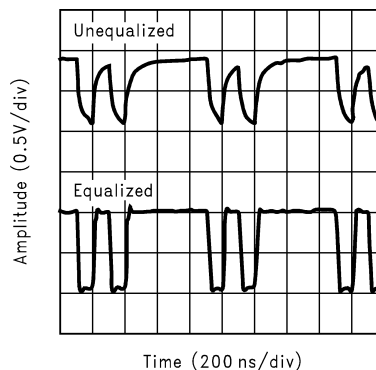
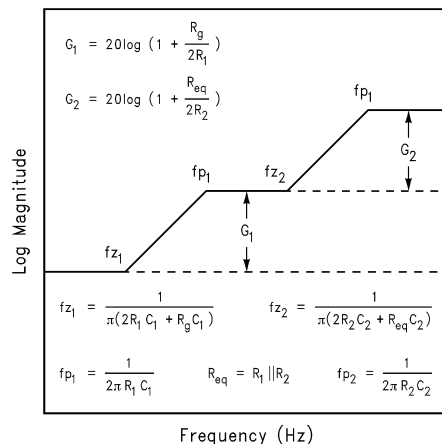
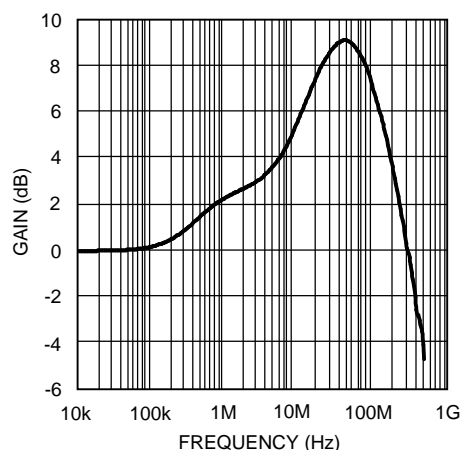


Figure 39. Digital Signal without and with Equalization



**Figure 40. Design Equations**



**Figure 41. Equalizer Frequency Response**

## POWER DISSIPATION

Follow these steps to determine the Maximum power dissipation for the LMH6714/LMH6720/LMH6722:

1. Calculate the quiescent (no load) power:  $P_{AMP} = I_{CC} (V_{CC} - V_{EE})$
2. Calculate the RMS power at the output stage:  $P_{OUT} (RMS) = ((V_{CC} - V_{OUT} (RMS)) * I_{OUT} (RMS))$ , where  $V_{OUT}$  and  $I_{OUT}$  are the voltage and current across the external load.
3. Calculate the total RMS power:  $P_T = P_{AMP} + P_{OUT}$

The maximum power that the LMH6714/LMH6720/LMH6722, package can dissipate at a given temperature can be derived with the following equation:

$P_{MAX} = (150^\circ - T_A) / \theta_{JA}$ , where  $T_A$  = Ambient temperature ( $^\circ C$ ) and  $\theta_{JA}$  = Thermal resistance, from junction to ambient, for a given package ( $^\circ C/W$ ). For the SOIC package  $\theta_{JA}$  is  $145^\circ C/W$ , for the 5-pin SOT-23 it is  $232^\circ C/W$ .

## REVISION HISTORY

| Changes from Revision F (April 2013) to Revision G         | Page               |
|--|--------------------|
| • Changed layout of National Data Sheet to TI format ..... | <a href="#">15</a> |



**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| LMH6714MA        | NRND          | SOIC         | D                  | 8    | 95             | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| LMH6714MA/NOPB   | ACTIVE        | SOIC         | D                  | 8    | 95             | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>14MA           | <a href="#">Samples</a> |
| LMH6714MAX/NOPB  | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>14MA           | <a href="#">Samples</a> |
| LMH6714MF        | NRND          | SOT-23       | DBV                | 5    | 1000           | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| LMH6714MF/NOPB   | ACTIVE        | SOT-23       | DBV                | 5    | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | A95A                    | <a href="#">Samples</a> |
| LMH6714MFX/NOPB  | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | A95A                    | <a href="#">Samples</a> |
| LMH6720MA        | NRND          | SOIC         | D                  | 8    | 95             | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| LMH6720MA/NOPB   | ACTIVE        | SOIC         | D                  | 8    | 95             | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>20MA           | <a href="#">Samples</a> |
| LMH6720MAX       | NRND          | SOIC         | D                  | 8    | 2500           | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| LMH6720MAX/NOPB  | ACTIVE        | SOIC         | D                  | 8    | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>20MA           | <a href="#">Samples</a> |
| LMH6720MF/NOPB   | ACTIVE        | SOT-23       | DBV                | 6    | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | A96A                    | <a href="#">Samples</a> |
| LMH6720MFX/NOPB  | ACTIVE        | SOT-23       | DBV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | A96A                    | <a href="#">Samples</a> |
| LMH6722MA        | NRND          | SOIC         | D                  | 14   | 55             | TBD                        | Call TI                 | Call TI              | -40 to 85    | LMH67<br>22MA           |                         |
| LMH6722MA/NOPB   | ACTIVE        | SOIC         | D                  | 14   | 55             | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>22MA           | <a href="#">Samples</a> |
| LMH6722MAX       | NRND          | SOIC         | D                  | 14   | 2500           | TBD                        | Call TI                 | Call TI              | -40 to 85    |                         |                         |
| LMH6722MAX/NOPB  | ACTIVE        | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>22MA           | <a href="#">Samples</a> |
| LMH6722MT/NOPB   | ACTIVE        | TSSOP        | PW                 | 14   | 94             | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>22MT           | <a href="#">Samples</a> |
| LMH6722MTX/NOPB  | ACTIVE        | TSSOP        | PW                 | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | LMH67<br>22MT           | <a href="#">Samples</a> |
| LMH6722QSD/NOPB  | ACTIVE        | WSO          | NHK                | 14   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 125   | L6722Q                  | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| LMH6722QSDX/NOPB | ACTIVE        | WSO          | NHK                | 14   | 4500           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 125   | L6722Q                  | <a href="#">Samples</a> |
| LMH6722SD/NOPB   | ACTIVE        | WSO          | NHK                | 14   | 1000           | Green (RoHS<br>& no Sb/Br) | CU SN                   | Level-1-260C-UNLIM   | -40 to 85    | L6722                   | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF LMH6722, LMH6722-Q1 :**

- Catalog: [LMH6722](#)
- Automotive: [LMH6722-Q1](#)

**NOTE:** Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LMH6714MAX/NOPB  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LMH6714MF/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMH6714MFX/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMH6720MAX/NOPB  | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.5     | 5.4     | 2.0     | 8.0     | 12.0   | Q1            |
| LMH6720MF/NOPB   | SOT-23       | DBV             | 6    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMH6720MFX/NOPB  | SOT-23       | DBV             | 6    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LMH6722MAX/NOPB  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.35    | 2.3     | 8.0     | 16.0   | Q1            |
| LMH6722MTX/NOPB  | TSSOP        | PW              | 14   | 2500 | 330.0              | 12.4               | 6.95    | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| LMH6722QSD/NOPB  | WSO          | NHK             | 14   | 1000 | 178.0              | 12.4               | 3.3     | 4.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LMH6722QSDX/NOPB | WSO          | NHK             | 14   | 4500 | 330.0              | 12.4               | 3.3     | 4.3     | 1.0     | 8.0     | 12.0   | Q1            |
| LMH6722SD/NOPB   | WSO          | NHK             | 14   | 1000 | 178.0              | 12.4               | 3.3     | 4.3     | 1.0     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LMH6714MAX/NOPB  | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LMH6714MF/NOPB   | SOT-23       | DBV             | 5    | 1000 | 210.0       | 185.0      | 35.0        |
| LMH6714MFX/NOPB  | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| LMH6720MAX/NOPB  | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| LMH6720MF/NOPB   | SOT-23       | DBV             | 6    | 1000 | 210.0       | 185.0      | 35.0        |
| LMH6720MFX/NOPB  | SOT-23       | DBV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| LMH6722MAX/NOPB  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 35.0        |
| LMH6722MTX/NOPB  | TSSOP        | PW              | 14   | 2500 | 367.0       | 367.0      | 35.0        |
| LMH6722QSD/NOPB  | WSO          | NHK             | 14   | 1000 | 210.0       | 185.0      | 35.0        |
| LMH6722QSDX/NOPB | WSO          | NHK             | 14   | 4500 | 367.0       | 367.0      | 35.0        |
| LMH6722SD/NOPB   | WSO          | NHK             | 14   | 1000 | 210.0       | 185.0      | 35.0        |

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-178 Variation AA.

DBV (R-PDSO-G5)

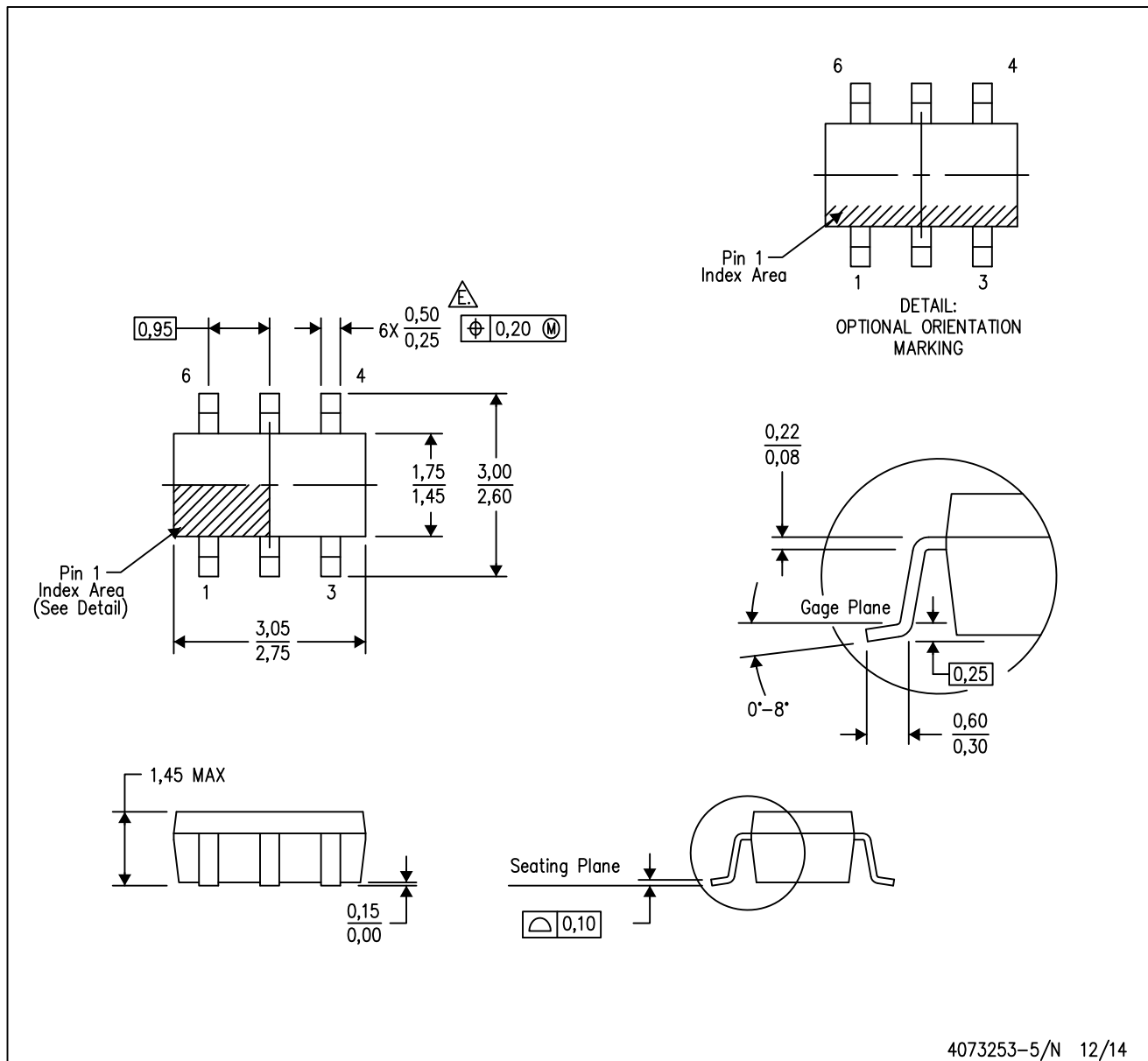
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

DBV (R-PDSO-G6)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
  - E. Falls within JEDEC MO-178 Variation AB, except minimum lead width.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

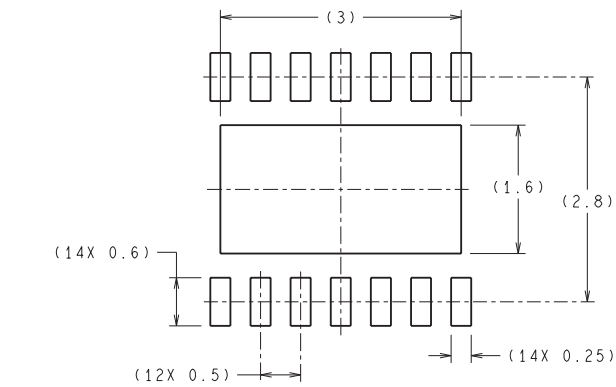
PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

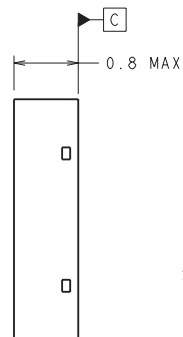
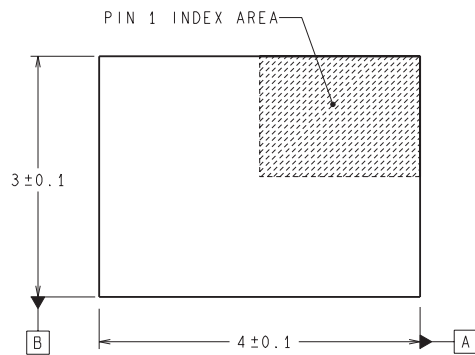


- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

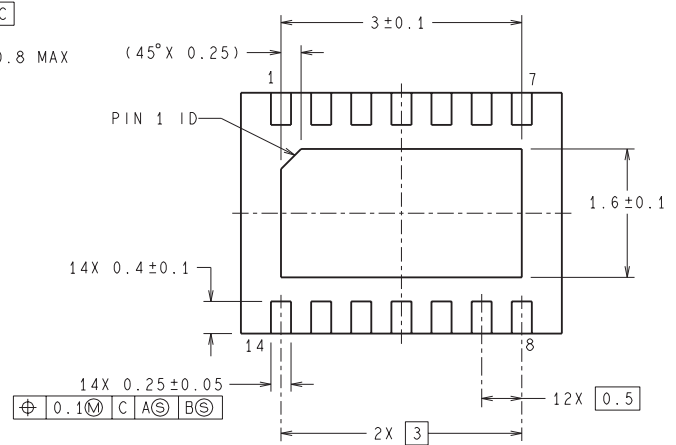
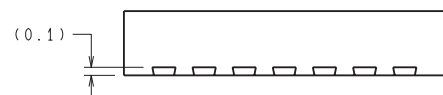
NHK0014A



## RECOMMENDED LAND PATTERN



**DIMENSIONS ARE IN MILLIMETERS**  
DIMENSIONS IN ( ) FOR REFERENCE ONLY



SDA14A (Rev A)

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



## NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.

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